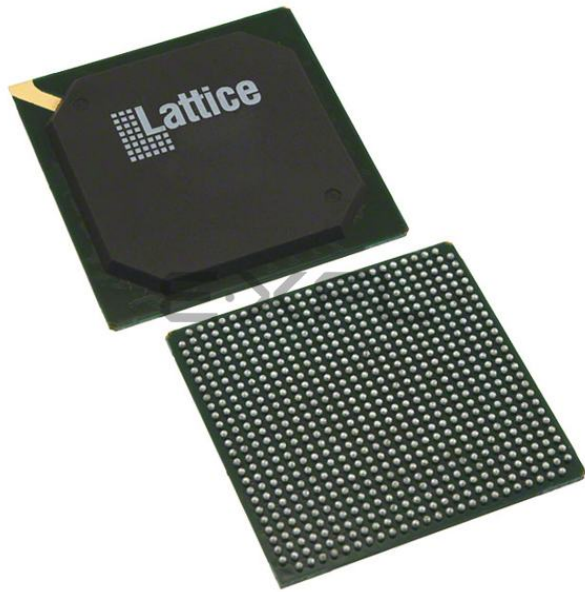




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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	19700
Total RAM Bits	434176
Number of I/O	400
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfecp20e-5fn672c

Architecture Overview

The LatticeECP-DSP and LatticeEC architectures contain an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM Embedded Block RAM (EBR), as shown in Figures 2-1 and 2-2. In addition, LatticeECP-DSP supports an additional row of DSP blocks, as shown in Figure 2-2.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional unit without RAM/ROM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM, ROM and register functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row. The PFU blocks are used on the outside rows. The rest of the core consists of rows of PFF blocks interspersed with rows of PFU blocks. For every three rows of PFF blocks there is a row of PFU blocks.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. sysMEM EBRs are large dedicated fast memory blocks. They can be configured as RAM or ROM.

The PFU, PFF, PIC and EBR Blocks are arranged in a two-dimensional grid with rows and columns as shown in Figure 2-1. The blocks are connected with many vertical and horizontal routing channel resources. The place and route software tool automatically allocates these routing resources.

At the end of the rows containing the sysMEM Blocks are the sysCLOCK Phase Locked Loop (PLL) Blocks. These PLLs have multiply, divide and phase shifting capability; they are used to manage the phase relationship of the clocks. The LatticeECP/EC architecture provides up to four PLLs per device.

Every device in the family has a JTAG Port with internal Logic Analyzer (ispTRACY) capability. The sysCONFIG™ port which allows for serial or parallel device configuration. The LatticeECP/EC devices use 1.2V as their core voltage.

grammed during configuration or can be adjusted dynamically. In dynamic mode, the PLL may lose lock after adjustment and not relock until the t_{LOCK} parameter has been satisfied. Additionally, the phase and duty cycle block allows the user to adjust the phase and duty cycle of the CLKOS output.

The sysCLOCK PLLs provide the ability to synthesize clock frequencies. Each PLL has four dividers associated with it: input clock divider, feedback divider, post scalar divider and secondary clock divider. The input clock divider is used to divide the input clock signal, while the feedback divider is used to multiply the input clock signal. The post scalar divider allows the VCO to operate at higher frequencies than the clock output, thereby increasing the frequency range. The secondary divider is used to derive lower frequency outputs.

Figure 2-11. PLL Diagram

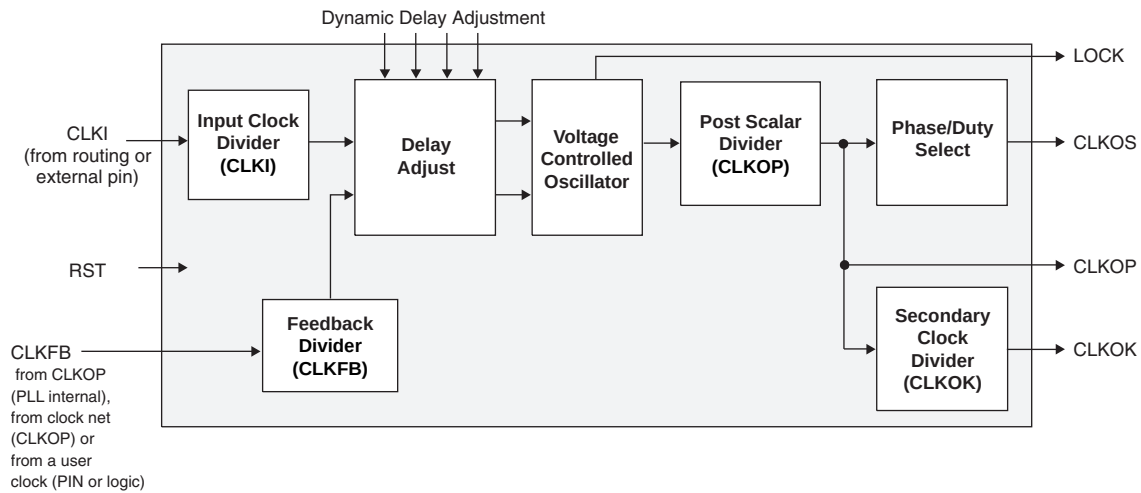
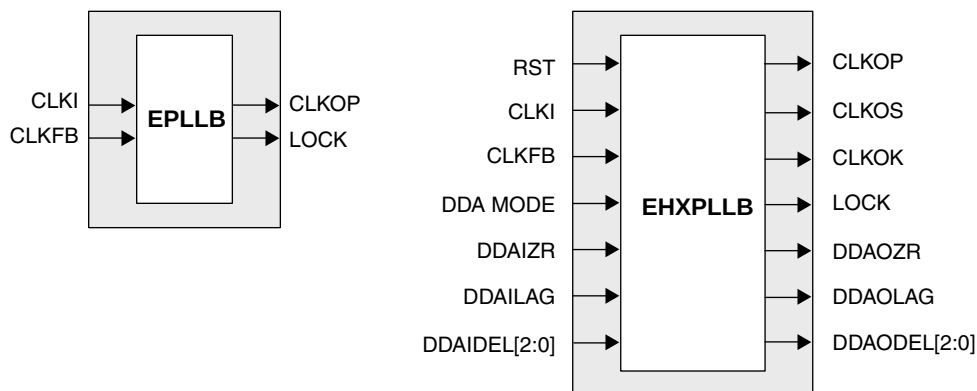


Figure 2-12 shows the available macros for the PLL. Table 2-5 provides signal description of the PLL Block.

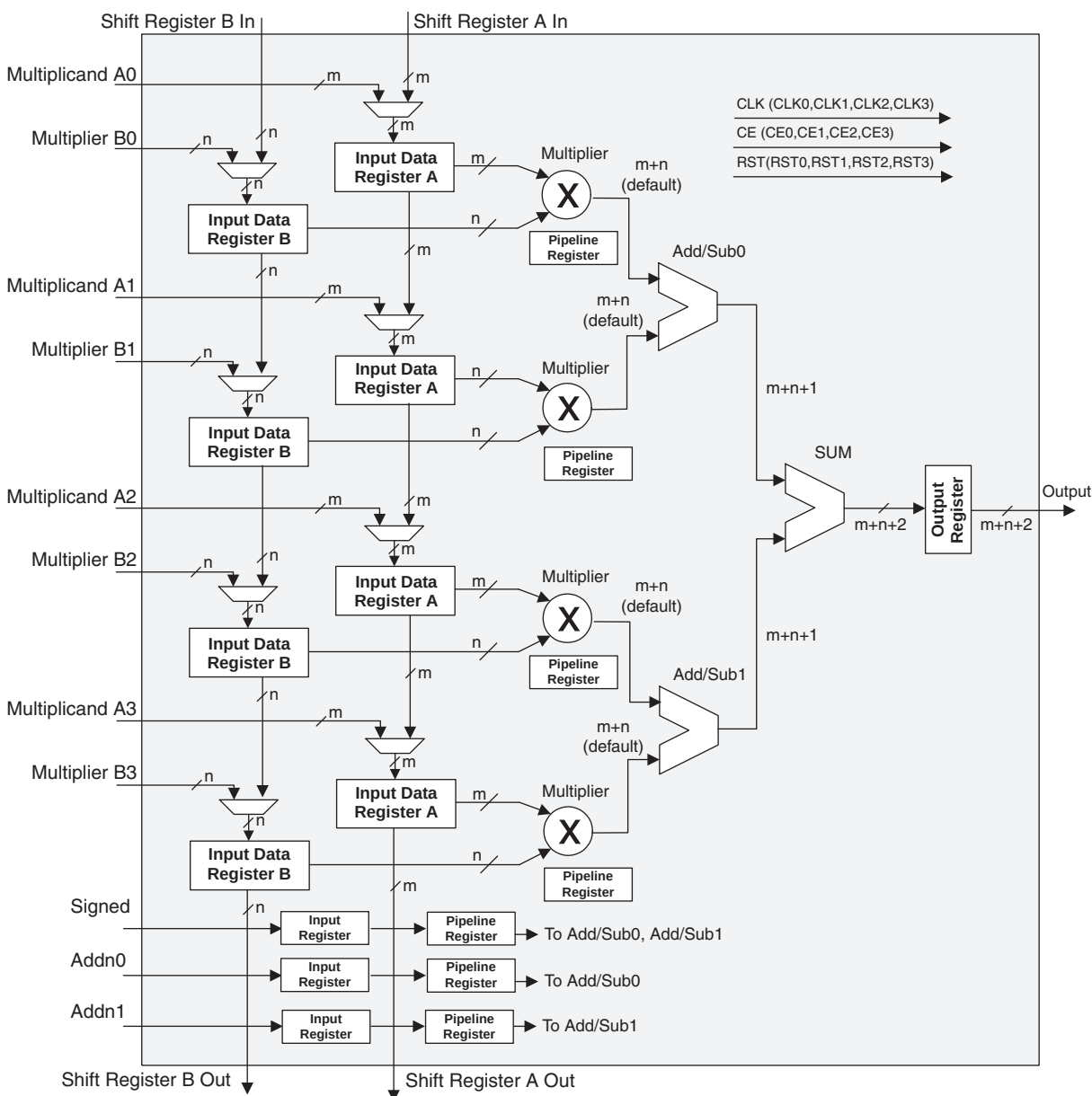
Figure 2-12. PLL Primitive



MULTADDSUM sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and B1. Additionally the operands A2 and B2 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A3 and B3. The result of both addition/subtraction are added in a summation block. The user can enable the input, output and pipeline registers. Figure 2-22 shows the MULTADDSUM sysDSP element.

Figure 2-22. MULTADDSUM



Clock, Clock Enable and Reset Resources

Global Clock, Clock Enable and Reset signals from routing are available to every DSP block. Four Clock, Reset and Clock Enable signals are selected for the sysDSP block. From four clock sources (CLK0, CLK1, CLK2, CLK3) one clock is selected for each input register, pipeline register and output register. Similarly Clock enable (CE) and Reset (RST) are selected from their four respective sources (CE0, CE1, CE2, CE3 and RST0, RST1, RST2, RST3) at each input register, pipeline register and output register.

Input Register Block

The input register block contains delay elements and registers that can be used to condition signals before they are passed to the device core. Figure 2-26 shows the diagram of the input register block.

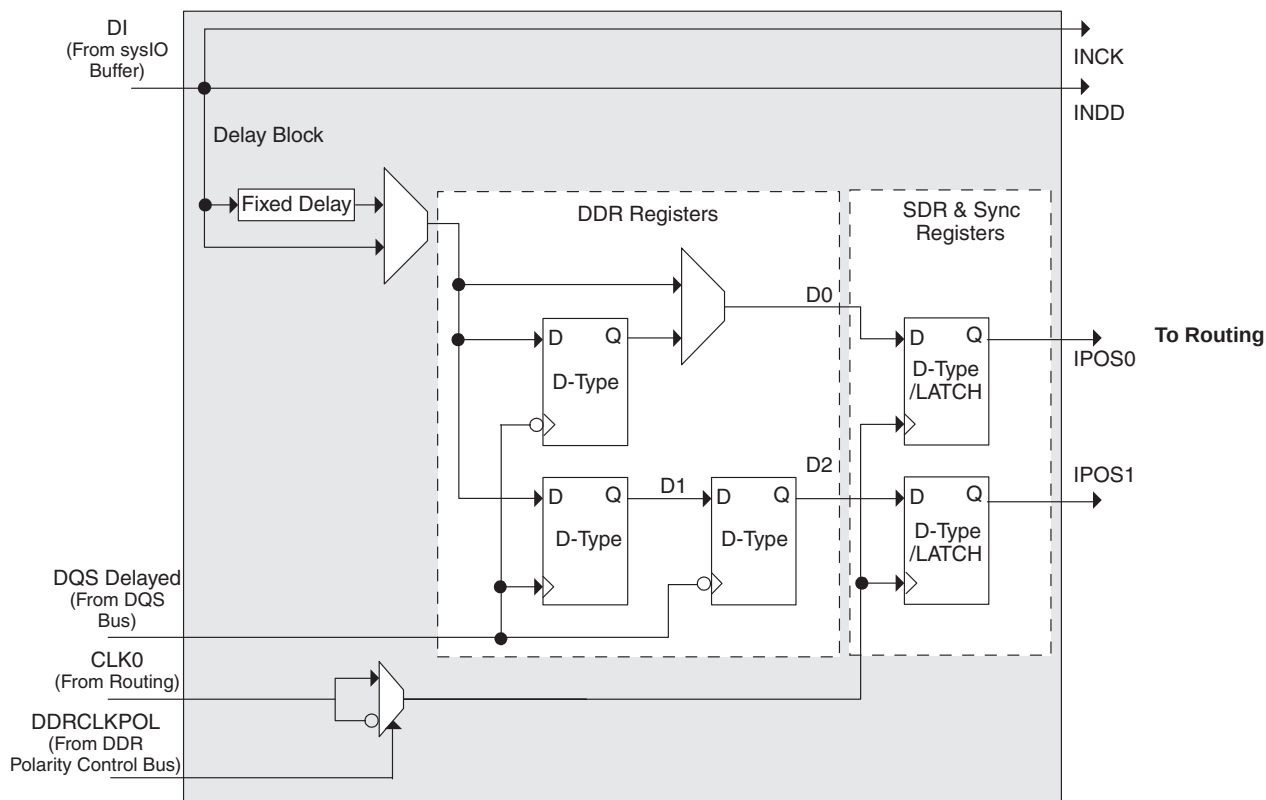
Input signals are fed from the sysI/O buffer to the input register block (as signal DI). If desired the input signal can bypass the register and delay elements and be used directly as a combinatorial signal (INDD), a clock (INCK) and in selected blocks the input to the DQS delay block. If one of the bypass options is not chosen, the signal first passes through an optional delay block. This delay, if selected, reduces input-register hold-time requirement when using a global clock.

The input block allows two modes of operation. In the single data rate (SDR) the data is registered, by one of the registers in the single data rate sync register block, with the system clock. In the DDR Mode two registers are used to sample the data on the positive and negative edges of the DQS signal creating two data streams, D0 and D2. These two data streams are synchronized with the system clock before entering the core. Further discussion on this topic is in the DDR Memory section of this data sheet.

Figure 2-27 shows the input register waveforms for DDR operation and Figure 2-28 shows the design tool primitives. The SDR/SYNC registers have reset and clock enable available.

The signal DDRCLKPOL controls the polarity of the clock used in the synchronization registers. It ensures adequate timing when data is transferred from the DQS to system clock domain. For further discussion on this topic, see the DDR Memory section of this data sheet.

Figure 2-26. Input Register Diagram



Differential HSTL and SSTL

Differential HSTL and SSTL outputs are implemented as a pair of complementary single-ended outputs. All allowable single-ended output classes (class I and class II) are supported in this mode.

LVDS25E

The top and bottom side of LatticeECP/EC devices support LVDS outputs via emulated complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The scheme shown in

Figure 3-1 is one possible solution for point-to-point signals.

Figure 3-1. LVDS25E Output Termination Example

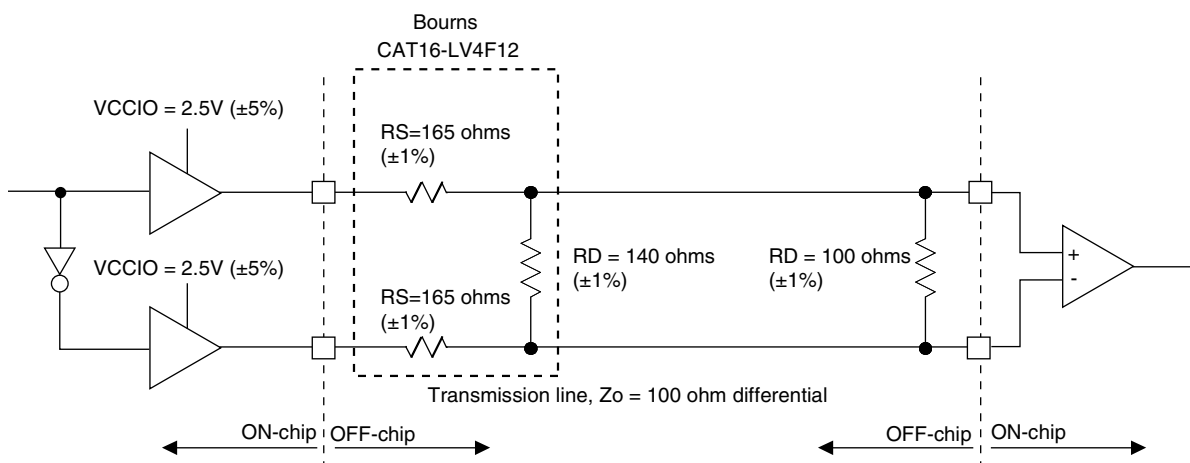


Table 3-1. LVDS25E DC Conditions

Parameter	Description	Typical	Units
V _{OH}	Output high voltage	1.42	V
V _{OL}	Output low voltage	1.08	V
V _{OD}	Output differential voltage	0.35	V
V _{CM}	Output common mode voltage	1.25	V
Z _{BACK}	Back impedance	100	Ω

Typical Building Block Function Performance

Pin-to-Pin Performance (LVCMOS25 12mA Drive)

Function	-5 Timing	Units
Basic Functions		
16-bit decoder	5.5	ns
32-bit decoder	6.9	ns
64-bit decoder	7.1	ns
4:1 MUX	4.3	ns
8:1 MUX	4.7	ns
16:1 MUX	5.0	ns
32:1 MUX	5.5	ns

Register-to-Register Performance¹

Function	-5 Timing	Units
Basic Functions		
16 bit decoder	410	MHz
32 bit decoder	283	MHz
64 bit decoder	272	MHz
4:1 MUX	613	MHz
8:1 MUX	565	MHz
16:1 MUX	526	MHz
32:1 MUX	442	MHz
8-bit adder	363	MHz
16-bit adder	353	MHz
64-bit adder	196	MHz
16-bit counter	414	MHz
32-bit counter	317	MHz
64-bit counter	216	MHz
64-bit accumulator	178	MHz
Embedded Memory Functions		
256x36 Single Port RAM	280	MHz
512x18 True-Dual Port RAM	280	MHz
Distributed Memory Functions		
16x2 Single Port RAM	460	MHz
64x2 Single Port RAM	375	MHz
128x4 Single Port RAM	294	MHz
32x2 Pseudo-Dual Port RAM	392	MHz
64x4 Pseudo-Dual Port RAM	332	MHz
DSP Function²		
9x9 Pipelined Multiply/Accumulate	242	MHz
18x18 Pipelined Multiply/Accumulate	238	MHz
36x36 Pipelined Multiply	235	MHz

1. These timing numbers were generated using the ispLEVER design tool. Exact performance may vary with design and tool version. The tool uses internal parameters that have been characterized but are not tested on every device.

2. Applies to LatticeECP devices only.

Timing v.G 0.30

Timing Diagrams

PFU Timing Diagrams

Figure 3-6. Slice Single/Dual Port Write Cycle Timing

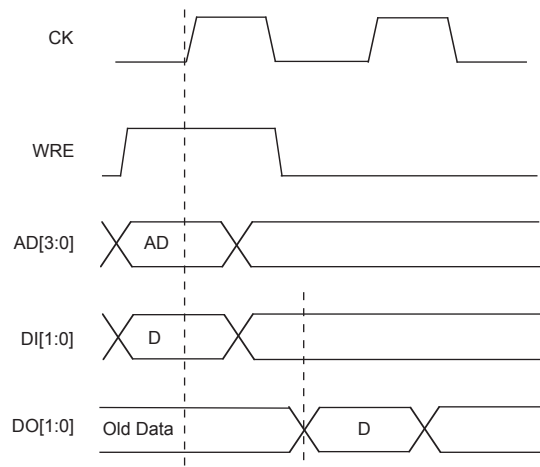


Figure 3-7. Slice Single /Dual Port Read Cycle Timing



Signal Descriptions (Cont.)

Signal Name	I/O	Description
TDI	I	Test Data in pin. Used to load data into device using 1149.1 state machine. After power-up, this TAP port can be activated for configuration by sending appropriate command. (Note: once a configuration port is selected it is locked. Another configuration port cannot be selected until the power-up sequence). Pull-up is enabled during configuration.
TDO	O	Output pin. Test Data out pin used to shift data out of device using 1149.1.
V _{CCJ}	—	V _{CCJ} - The power supply pin for JTAG Test Access Port.
Configuration Pads (used during sysCONFIG)		
CFG[2:0]	I	Mode pins used to specify configuration modes values latched on rising edge of INITN. During configuration, a pull-up is enabled. These are dedicated pins.
INITN	I/O	Open Drain pin. Indicates the FPGA is ready to be configured. During configuration, a pull-up is enabled. It is a dedicated pin.
PROGRAMN	I	Initiates configuration sequence when asserted low. This pin always has an active pull-up. This is a dedicated pin.
DONE	I/O	Open Drain pin. Indicates that the configuration sequence is complete, and the startup sequence is in progress. This is a dedicated pin.
CCLK	I/O	Configuration Clock for configuring an FPGA in sysCONFIG mode.
BUSY/SISPI	I/O	Read control command in SPI3 or SPIX mode.
CSN	I	sysCONFIG chip select (Active low). During configuration, a pull-up is enabled.
CS1N	I	sysCONFIG chip select (Active low). During configuration, a pull-up is enabled.
WRITEN	I	Write Data on Parallel port (Active low).
D[7:0]/SPID[0:7]	I/O	sysCONFIG Port Data I/O.
DOUT/CSO	O	Output for serial configuration data (rising edge of CCLK) when using sysCONFIG port.
DI/CSSPIN	I/O	Input for serial configuration data (clocked with CCLK) when using sysCONFIG port. During configuration, a pull-up is enabled. Output when used in SPI/SPIX modes.

Pin Information Summary

		LFEC1			LFEC3				LFEC6/EC6				LFEC6/EC10		
Pin Type		100-TQFP	144-TQFP	208-PQFP	100-TQFP	144-TQFP	208-PQFP	256-fpBGA	144-TQFP	208-PQFP	256-fpBGA	484-fpBGA	208-PQFP	256-fpBGA	484-fpBGA
Single Ended User I/O		67	97	112	67	97	145	160	97	147	195	224	147	195	288
Differential Pair User I/O		29	46	56	29	46	72	80	46	72	97	112	72	97	144
Configu-ration	Dedicated	13	13	13	13	13	13	13	13	13	13	13	13	13	13
	Muxed	48	48	48	48	48	48	48	48	48	48	48	56	56	56
TAP		5	5	5	5	5	5	5	5	5	5	5	5	5	5
Dedicated (total without supplies)		80	110	160	80	110	160	208	110	160	208	373	160	208	373
V _{CC}		2	3	3	2	3	3	10	4	4	10	20	6	10	20
V _{CCAUX}		2	2	2	4	4	4	4	2	4	2	12	4	2	12
V _{CCPLL}		0	0	0	0	0	0	0	0	0	0	0	0	0	0
V _{CCIO}	Bank0	1	2	2	1	2	3	2	2	3	2	4	3	2	4
	Bank1	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank2	1	1	1	2	2	2	2	1	2	2	4	2	2	4
	Bank3	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank4	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank5	1	2	2	1	2	2	2	2	3	2	4	3	2	4
	Bank6	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank7	1	1	1	2	2	2	2	1	2	2	4	2	2	4
GND, GND0-GND7		8	13	13	8	13	16	20	14	18	20	44	20	20	44
NC		0	2	51	0	2	9	35	0	4	0	139	0	0	75
Single Ended/Differential I/O Pair per Bank	Bank 0	11/5	14/7	16/8	11/5	14/7	26/13	32/16	14/7	26/13	32/16	32/16	26/13	32/16	48/24
	Bank 1	11/5	13/6	16/8	11/5	13/6	16/8	16/8	13/6	17/8	18/9	32/16	17/8	18/9	32/16
	Bank 2	3/1	8/4	8/4	3/1	8/4	14/7	16/8	8/4	14/7	16/8	16/8	14/7	16/8	32/16
	Bank 3	8/4	13/6	16/8	8/4	13/6	16/8	16/8	13/6	16/8	32/16	32/16	16/8	32/16	32/16
	Bank 4	12/4	14/6	16/8	12/4	14/6	16/8	16/8	14/6	17/8	17/8	32/16	17/8	17/8	32/16
	Bank 5	9/4	13/6	16/8	9/4	13/6	26/13	32/16	13/6	26/13	32/16	32/16	26/13	32/16	48/24
	Bank 6	5/2	14/7	16/8	5/2	14/7	16/8	16/8	14/7	16/8	32/16	32/16	16/8	32/16	32/16
	Bank 7	8/4	8/4	8/4	8/4	8/4	15/7	16/8	8/4	15/7	16/8	16/8	15/7	16/8	32/16
V _{CCJ}		1	1	1	1	1	1	1	1	1	1	1	1	1	1

Note: During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration.

LFEC1, LFEC3 Logic Signal Connections: 100 TQFP

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
1*	GND0 GND7	-			GND0 GND7	-		
2	VCCIO7	7			VCCIO7	7		
3	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7
4	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7
5	PL3A	7	T		PL7A	7	T	
6	PL3B	7	C		PL7B	7	C	
7	PL4A	7	T		PL8A	7	T	
8	PL4B	7	C		PL8B	7	C	
9	PL5A	7	T	PCLKT7_0	PL9A	7	T	PCLKT7_0
10	PL5B	7	C	PCLKC7_0	PL9B	7	C	PCLKC7_0
11	XRES	6			XRES	6		
12	VCC	-			VCC	-		
13	TCK	6			TCK	6		
14	GND	-			GND	-		
15	TDI	6			TDI	6		
16	TMS	6			TMS	6		
17	TDO	6			TDO	6		
18	VCCJ	6			VCCJ	6		
19	PL7A	6	T	LLM0_PLLT_IN_A	PL11A	6	T	LUM0_PLLT_IN_A
20	PL7B	6	C	LLM0_PLLC_IN_A	PL11B	6	C	LUM0_PLLC_IN_A
21	PL8A	6	T	LLM0_PLLT_FB_A	PL12A	6	T	LUM0_PLLT_FB_A
22	PL8B	6	C	LLM0_PLLC_FB_A	PL12B	6	C	LUM0_PLLC_FB_A
23	PL14A	6		VREF1_6	PL18A	6		VREF1_6
24	VCCIO6	6			VCCIO6	6		
25*	GND5 GND6	-			GND5 GND6	-		
26	VCCIO5	5			VCCIO5	5		
27	PB2A	5	T		PB10A	5	T	
28	PB2B	5	C		PB10B	5	C	
29	PB3A	5	T		PB11A	5	T	
30	PB3B	5	C		PB11B	5	C	
31	PB6A	5		BDQS6	PB14A	5		BDQS14
32	PB8A	5	T	VREF2_5	PB16A	5	T	VREF2_5
33	PB8B	5	C	VREF1_5	PB16B	5	C	VREF1_5
34	PB9A	5	T	PCLKT5_0	PB17A	5	T	PCLKT5_0
35	GND5	5			GND5	5		
36	PB9B	5	C	PCLKC5_0	PB17B	5	C	PCLKC5_0
37	VCCAUX	-			VCCAUX	-		
38	VCCIO4	4			VCCIO4	4		
39	PB10A	4	T	WRITEN	PB18A	4	T	WRITEN
40	PB10B	4	C	CS1N	PB18B	4	C	CS1N

LFEC1, LFEC3, LFEC6/EC6 Logic Signal Connections: 144 TQFP (Cont.)

Pin Number	LFEC1				LFEC3				LFEC6/EC6			
	Pin Function	Bank	LVD S	Dual Function	Pin Function	Bank	LVD S	Dual Function	Pin Function	Bank	LVD S	Dual Function
99	VCC	-			VCC	-			VCC	-		
100	PR5B	2	C	PCLKC2_0	PR9B	2	C	PCLKC2_0	PR9B	2	C	PCLKC2_0
101	PR5A	2	T	PCLKT2_0	PR9A	2	T	PCLKT2_0	PR9A	2	T	PCLKT2_0
102	PR4B	2	C		PR8B	2	C		PR8B	2	C	
103	PR4A	2	T		PR8A	2	T		PR8A	2	T	
104	PR3B	2	C		PR7B	2	C		PR7B	2	C	
105	PR3A	2	T		PR7A	2	T		PR7A	2	T	
106	PR2B	2	C	VREF1_2	PR2B	2	C	VREF1_2	PR2B	2	C	VREF1_2
107	PR2A	2	T	VREF2_2	PR2A	2	T	VREF2_2	PR2A	2	T	VREF2_2
108	VCCIO2	2			VCCIO2	2			VCCIO2	2		
109*	GND1 GND2	-			GND1 GND2	-			GND1 GND2	-		
110	VCCIO1	1			VCCIO1	1			VCCIO1	1		
111	PT17B	1	C		PT25B	1	C		PT25B	1	C	
112	PT17A	1	T		PT25A	1	T		PT25A	1	T	
113	PT15A	1			PT23A	1			PT23A	1		
114	PT14B	1	C		PT22B	1	C		PT22B	1	C	
115	PT14A	1	T	TDQS14	PT22A	1	T	TDQS22	PT22A	1	T	TDQS22
116	PT13B	1	C		PT21B	1	C		PT21B	1	C	
117	GND1	1			GND1	1			GND1	1		
118	PT13A	1	T		PT21A	1	T		PT21A	1	T	
119	PT12B	1	C		PT20B	1	C		PT20B	1	C	
120	PT12A	1	T		PT20A	1	T		PT20A	1	T	
121	PT11B	1	C	VREF2_1	PT19B	1	C	VREF2_1	PT19B	1	C	VREF2_1
122	PT11A	1	T	VREF1_1	PT19A	1	T	VREF1_1	PT19A	1	T	VREF1_1
123	PT10B	1	C		PT18B	1	C		PT18B	1	C	
124	PT10A	1	T		PT18A	1	T		PT18A	1	T	
125	VCCIO1	1			VCCIO1	1			VCCIO1	1		
126	VCCAUX	-			VCCAUX	-			VCCAUX	-		
127	PT9B	0	C	PCLKC0_0	PT17B	0	C	PCLKC0_0	PT17B	0	C	PCLKC0_0
128	GND0	0			GND0	0			GND0	0		
129	PT9A	0	T	PCLKT0_0	PT17A	0	T	PCLKT0_0	PT17A	0	T	PCLKT0_0
130	PT8B	0	C	VREF1_0	PT16B	0	C	VREF1_0	PT16B	0	C	VREF1_0
131	PT8A	0	T	VREF2_0	PT16A	0	T	VREF2_0	PT16A	0	T	VREF2_0
132	PT7B	0	C		PT15B	0	C		PT15B	0	C	
133	PT7A	0	T		PT15A	0	T		PT15A	0	T	
134	PT6B	0	C		PT14B	0	C		PT14B	0	C	
135	PT6A	0	T	TDQS6	PT14A	0	T	TDQS14	PT14A	0	T	TDQS14
136	VCCIO0	0			VCCIO0	0			VCCIO0	0		
137	PT5B	0	C		PT13B	0	C		PT13B	0	C	
138	PT5A	0	T		PT13A	0	T		PT13A	0	T	
139	PT4B	0	C		PT12B	0	C		PT12B	0	C	
140	PT4A	0	T		PT12A	0	T		PT12A	0	T	
141	PT2B	0	C		PT10B	0	C		PT10B	0	C	
142	PT2A	0	T		PT10A	0	T		PT10A	0	T	
143	VCCIO0	0			VCCIO0	0			VCCIO0	0		
144*	GND0 GND7	-			GND0 GND7	-			GND0 GND7	-		

*Double bonded to the pin.

LFEC6/EC6, LFEC6/EC10 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC6/LFEC6				LFEC10/LFEC10			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
169	PT21A	1	T		PT29A	1	T	
170	PT20B	1	C		PT28B	1	C	
171	PT20A	1	T		PT28A	1	T	
172	PT19B	1	C	VREF2_1	PT27B	1	C	VREF2_1
173	PT19A	1	T	VREF1_1	PT27A	1	T	VREF1_1
174	PT18B	1	C		PT26B	1	C	
175	PT18A	1	T		PT26A	1	T	
176	VCCIO1	1			VCCIO1	1		
177	VCCAUX	-			VCCAUX	-		
178	PT17B	0	C	PCLKC0_0	PT25B	0	C	PCLKC0_0
179	GND0	0			GND0	0		
180	PT17A	0	T	PCLKT0_0	PT25A	0	T	PCLKT0_0
181	PT16B	0	C	VREF1_0	PT24B	0	C	VREF1_0
182	PT16A	0	T	VREF2_0	PT24A	0	T	VREF2_0
183	PT15B	0	C		PT23B	0	C	
184	PT15A	0	T		PT23A	0	T	
185	PT14B	0	C		PT22B	0	C	
186	PT14A	0	T	TDQS14	PT22A	0	T	TDQS22
187	VCCIO0	0			VCCIO0	0		
188	PT13B	0	C		PT21B	0	C	
189	GND0	0			GND0	0		
190	PT13A	0	T		PT21A	0	T	
191	PT12B	0	C		PT20B	0	C	
192	PT12A	0	T		PT20A	0	T	
193	PT11B	0	C		PT19B	0	C	
194	PT11A	0	T		PT19A	0	T	
195	PT10B	0	C		PT18B	0	C	
196	PT10A	0	T		PT18A	0	T	
197	VCCIO0	0			VCCIO0	0		
198	PT6B	0	C		PT6B	0	C	
199	PT6A	0	T	TDQS6	PT6A	0	T	TDQS6
200	PT5B	0	C		PT5B	0	C	
201	PT5A	0	T		PT5A	0	T	
202	PT4B	0	C		PT4B	0	C	
203	PT4A	0	T		PT4A	0	T	
204	PT3B	0	C		PT3B	0	C	
205	PT3A	0	T		PT3A	0	T	
206	PT2B	0	C		PT2B	0	C	
207	PT2A	0	T		PT2A	0	T	
208	VCCIO0	0			VCCIO0	0		

*Double bonded to the pin.

LFEC/EC10 and LFEC/EC15 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC/EC10				LFEC/EC15			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
A10	PT25B	0	C	PCLKC0_0	PT25B	0	C	PCLKC0_0
GND	GND0	0			GND0	0		
B10	PT25A	0	T	PCLKT0_0	PT25A	0	T	PCLKT0_0
C9	PT24B	0	C	VREF1_0	PT24B	0	C	VREF1_0
B9	PT24A	0	T	VREF2_0	PT24A	0	T	VREF2_0
E9	PT23B	0	C		PT23B	0	C	
D9	PT23A	0	T		PT23A	0	T	
D8	PT22B	0	C		PT22B	0	C	
C8	PT22A	0	T	TDQS22	PT22A	0	T	TDQS22
A9	PT21B	0	C		PT21B	0	C	
GND	GND0	0			GND0	0		
A8	PT21A	0	T		PT21A	0	T	
B8	PT20B	0	C		PT20B	0	C	
B7	PT20A	0	T		PT20A	0	T	
D7	PT19B	0	C		PT19B	0	C	
C7	PT19A	0	T		PT19A	0	T	
A7	PT18B	0	C		PT18B	0	C	
A6	PT18A	0	T		PT18A	0	T	
E7	PT17B	0	C		PT17B	0	C	
GND	GND0	0			GND0	0		
E6	PT17A	0	T		PT17A	0	T	
D6	PT16B	0	C		PT16B	0	C	
C6	PT16A	0	T		PT16A	0	T	
B6	PT15B	0	C		PT15B	0	C	
B5	PT15A	0	T		PT15A	0	T	
A5	PT14B	0	C		PT14B	0	C	
A4	PT14A	0	T	TDQS14	PT14A	0	T	TDQS14
A3	PT13B	0	C		PT13B	0	C	
-	GND0	0			GND0	0		
A2	PT13A	0	T		PT13A	0	T	
B2	PT12B	0	C		PT12B	0	C	
B3	PT12A	0	T		PT12A	0	T	
D5	PT11B	0	C		PT11B	0	C	
C5	PT11A	0	T		PT11A	0	T	
C4	PT10B	0	C		PT10B	0	C	
B4	PT10A	0	T		PT10A	0	T	
GND	GND0	0			GND0	0		
GND	GND0	0			GND0	0		
A1	GND	-			GND	-		
A16	GND	-			GND	-		
G10	GND	-			GND	-		
G7	GND	-			GND	-		
G8	GND	-			GND	-		

LFEC20/EC20 and LFEC20/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC20/EC20					LFEC20/EC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
K16	VCC	-			K16	VCC	-		
K17	VCC	-			K17	VCC	-		
K6	VCC	-			K6	VCC	-		
K7	VCC	-			K7	VCC	-		
L17	VCC	-			L17	VCC	-		
L6	VCC	-			L6	VCC	-		
M17	VCC	-			M17	VCC	-		
M6	VCC	-			M6	VCC	-		
N16	VCC	-			N16	VCC	-		
N17	VCC	-			N17	VCC	-		
N6	VCC	-			N6	VCC	-		
N7	VCC	-			N7	VCC	-		
P16	VCC	-			P16	VCC	-		
P7	VCC	-			P7	VCC	-		
G11	VCCIO0	0			G11	VCCIO0	0		
H10	VCCIO0	0			H10	VCCIO0	0		
H11	VCCIO0	0			H11	VCCIO0	0		
H9	VCCIO0	0			H9	VCCIO0	0		
G12	VCCIO1	1			G12	VCCIO1	1		
H12	VCCIO1	1			H12	VCCIO1	1		
H13	VCCIO1	1			H13	VCCIO1	1		
H14	VCCIO1	1			H14	VCCIO1	1		
J15	VCCIO2	2			J15	VCCIO2	2		
K15	VCCIO2	2			K15	VCCIO2	2		
L15	VCCIO2	2			L15	VCCIO2	2		
L16	VCCIO2	2			L16	VCCIO2	2		
M15	VCCIO3	3			M15	VCCIO3	3		
M16	VCCIO3	3			M16	VCCIO3	3		
N15	VCCIO3	3			N15	VCCIO3	3		
P15	VCCIO3	3			P15	VCCIO3	3		
R12	VCCIO4	4			R12	VCCIO4	4		
R13	VCCIO4	4			R13	VCCIO4	4		
R14	VCCIO4	4			R14	VCCIO4	4		
T12	VCCIO4	4			T12	VCCIO4	4		
R10	VCCIO5	5			R10	VCCIO5	5		
R11	VCCIO5	5			R11	VCCIO5	5		
R9	VCCIO5	5			R9	VCCIO5	5		
T11	VCCIO5	5			T11	VCCIO5	5		
M7	VCCIO6	6			M7	VCCIO6	6		
M8	VCCIO6	6			M8	VCCIO6	6		
N8	VCCIO6	6			N8	VCCIO6	6		
P8	VCCIO6	6			P8	VCCIO6	6		
J8	VCCIO7	7			J8	VCCIO7	7		
K8	VCCIO7	7			K8	VCCIO7	7		

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFEC20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
Y6	NC	-			Y6	PL62A	6	T	
W7	NC	-			W7	PL62B	6	C	
AA4	NC	-			AA4	PL63A	6	T	
AB3	NC	-			AB3	PL63B	6	C	
AC2	NC	-			AC2	PL64A	6	T	
-	-	-			GND	GND6	6		
AC3	NC	-			AC3	PL64B	6	C	
AA5	NC	-			AA5	PL65A	6	T	LDQS65
AB5	NC	-			AB5	PL65B	6	C	
AD3	NC	-			AD3	PL66A	6	T	
AD2	NC	-			AD2	PL66B	6	C	
AE1	NC	-			AE1	PL67A	6	T	
AD1	NC	-			AD1	PL67B	6	C	
AB4	PL48A	6	T	VREF1_6	AB4	PL68A	6	T	VREF1_6
AC4	PL48B	6	C	VREF2_6	AC4	PL68B	6	C	VREF2_6
GND	GND6	6			GND	GND6	6		
GND	GND5	5			GND	GND5	5		
AB6	PB2A	5	T		AB6	PB2A	5	T	
AA6	PB2B	5	C		AA6	PB2B	5	C	
AC7	PB3A	5	T		AC7	PB3A	5	T	
Y8	PB3B	5	C		Y8	PB3B	5	C	
AB7	PB4A	5	T		AB7	PB4A	5	T	
AA7	PB4B	5	C		AA7	PB4B	5	C	
AC6	PB5A	5	T		AC6	PB5A	5	T	
AC5	PB5B	5	C		AC5	PB5B	5	C	
AB8	PB6A	5	T	BDQS6	AB8	PB6A	5	T	BDQS6
AC8	PB6B	5	C		AC8	PB6B	5	C	
AE2	PB7A	5	T		AE2	PB7A	5	T	
AA8	PB7B	5	C		AA8	PB7B	5	C	
AF2	PB8A	5	T		AF2	PB8A	5	T	
Y9	PB8B	5	C		Y9	PB8B	5	C	
AD5	PB9A	5	T		AD5	PB9A	5	T	
GND	GND5	5			GND	GND5	5		
AD4	PB9B	5	C		AD4	PB9B	5	C	
AD8	PB10A	5	T		AD8	PB10A	5	T	
AC9	PB10B	5	C		AC9	PB10B	5	C	
AE3	PB11A	5	T		AE3	PB11A	5	T	
AB9	PB11B	5	C		AB9	PB11B	5	C	
AF3	PB12A	5	T		AF3	PB12A	5	T	
AD9	PB12B	5	C		AD9	PB12B	5	C	
AE4	PB13A	5	T		AE4	PB13A	5	T	
GND	GND5	5			GND	GND5	5		

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
AC13	PB32B	5	C	VREF1_5	AC13	PB32B	5	C	VREF1_5
AF14	PB33A	5	T	PCLKT5_0	AF14	PB33A	5	T	PCLKT5_0
GND	GND5	5			GND	GND5	5		
AE14	PB33B	5	C	PCLKC5_0	AE14	PB33B	5	C	PCLKC5_0
AA13	PB34A	4	T	WRITEN	AA13	PB34A	4	T	WRITEN
AB13	PB34B	4	C	CS1N	AB13	PB34B	4	C	CS1N
AD14	PB35A	4	T	VREF1_4	AD14	PB35A	4	T	VREF1_4
AA14	PB35B	4	C	CSN	AA14	PB35B	4	C	CSN
AC14	PB36A	4	T	VREF2_4	AC14	PB36A	4	T	VREF2_4
AB14	PB36B	4	C	D0/SPID7	AB14	PB36B	4	C	D0/SPID7
AF15	PB37A	4	T	D2/SPID5	AF15	PB37A	4	T	D2/SPID5
GND	GND4	4			GND	GND4	4		
AE15	PB37B	4	C	D1/SPID6	AE15	PB37B	4	C	D1/SPID6
AD15	PB38A	4	T	BDQS38	AD15	PB38A	4	T	BDQS38
AC15	PB38B	4	C	D3/SPID4	AC15	PB38B	4	C	D3/SPID4
AF16	PB39A	4	T		AF16	PB39A	4	T	
Y14	PB39B	4	C	D4/SPID3	Y14	PB39B	4	C	D4/SPID3
AE16	PB40A	4	T		AE16	PB40A	4	T	
AB15	PB40B	4	C	D5/SPID2	AB15	PB40B	4	C	D5/SPID2
AF17	PB41A	4	T		AF17	PB41A	4	T	
GND	GND4	4			GND	GND4	4		
AE17	PB41B	4	C	D6/SPID1	AE17	PB41B	4	C	D6/SPID1
Y15	PB42A	4	T		Y15	PB42A	4	T	
AA15	PB42B	4	C		AA15	PB42B	4	C	
AD17	PB43A	4	T		AD17	PB43A	4	T	
Y16	PB43B	4	C		Y16	PB43B	4	C	
AD18	PB44A	4	T		AD18	PB44A	4	T	
AC16	PB44B	4	C		AC16	PB44B	4	C	
AE18	PB45A	4	T		AE18	PB45A	4	T	
GND	GND4	4			GND	GND4	4		
AF18	PB45B	4	C		AF18	PB45B	4	C	
AD16	PB46A	4	T	BDQS46	AD16	PB46A	4	T	BDQS46
AB16	PB46B	4	C		AB16	PB46B	4	C	
AF19	PB47A	4	T		AF19	PB47A	4	T	
AA16	PB47B	4	C		AA16	PB47B	4	C	
AA17	PB48A	4	T		AA17	PB48A	4	T	
Y17	PB48B	4	C		Y17	PB48B	4	C	
AF21	PB49A	4	T		AF21	PB49A	4	T	
GND	GND4	4			GND	GND4	4		
AF20	PB49B	4	C		AF20	PB49B	4	C	
AE21	PB50A	4	T		AE21	PB50A	4	T	
AC17	PB50B	4	C		AC17	PB50B	4	C	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
E24	NC	-			E24	PR8B	2	C	
D24	NC	-			D24	PR8A	2	T	
E22	NC	-			E22	PR7B	2	C	
F22	NC	-			F22	PR7A	2	T	
E21	NC	-			E21	PR6B	2	C	
D22	NC	-			D22	PR6A	2	T	RDQS6
E23	PR2B	2	C	VREF1_2	E23	PR2B	2	C	VREF1_2
D23	PR2A	2	T	VREF2_2	D23	PR2A	2	T	VREF2_2
GND	GND2	2			GND	GND2	2		
GND	GND1	1			GND	GND1	1		
G20	NC	-			G20	PT65B	1	C	
F20	NC	-			F20	PT65A	1	T	
D21	NC	-			D21	PT64B	1	C	
C21	NC	-			C21	PT64A	1	T	
C23	NC	-			C23	PT63B	1	C	
C22	NC	-			C22	PT63A	1	T	
B23	NC	-			B23	PT62B	1	C	
C24	NC	-			C24	PT62A	1	T	TDQS62
D20	NC	-			D20	PT61B	1	C	
-	-	-			GND	GND1	1		
E19	NC	-			E19	PT61A	1	T	
B25	NC	-			B25	PT60B	1	C	
B24	NC	-			B24	PT60A	1	T	
B26	NC	-			B26	PT59B	1	C	
A25	NC	-			A25	PT59A	1	T	
C20	NC	-			C20	PT58B	1	C	
C19	NC	-			C19	PT58A	1	T	
A24	PT57B	1	C		A24	PT57B	1	C	
-	-	-			GND	GND1	1		
A23	PT57A	1	T		A23	PT57A	1	T	
E18	PT56B	1	C		E18	PT56B	1	C	
D19	PT56A	1	T		D19	PT56A	1	T	
F19	PT55B	1	C		F19	PT55B	1	C	
B22	PT55A	1	T		B22	PT55A	1	T	
G19	PT54B	1	C		G19	PT54B	1	C	
B21	PT54A	1	T	TDQS54	B21	PT54A	1	T	TDQS54
D18	PT53B	1	C		D18	PT53B	1	C	
GND	GND1	1			GND	GND1	1		
C18	PT53A	1	T		C18	PT53A	1	T	
F18	PT52B	1	C		F18	PT52B	1	C	
A22	PT52A	1	T		A22	PT52A	1	T	
G18	PT51B	1	C		G18	PT51B	1	C	



LatticeECP/EC Family Data Sheet Supplemental Information

September 2012

Data Sheet

For Further Information

A variety of technical notes for the LatticeECP/EC family are available on the Lattice web site at www.latticesemi.com.

- LatticeECP/EC sysIO Usage Guide (TN1056)
- LatticeECP/EC sysCLOCK PLL Design and Usage Guide (TN1049)
- Memory Usage Guide for LatticeECP/EC Devices (TN1051)
- LatticeECP/EC DDR Usage Guide (TN1050)
- Power Estimation and Management for LatticeECP/EC and LatticeXP Devices (TN1052)
- LatticeECP-DSP sysDSP Usage Guide (TN1057)
- LatticeECP/EC sysCONFIG Usage Guide (TN1053)
- IEEE 1149.1 Boundary Scan Testability in Lattice Devices

For further information about interface standards refer to the following web sites:

- JEDEC Standards (LVTTTL, LVCMOS, SSTL, HSTL): www.jedec.org
- PCI: www.pcisig.com

Date	Version	Section	Change Summary
December 2004	01.4	Architecture	Updated Hot Socketing Recommended Power Up Sequence section.
		Pinout Information	Added LFEC1, LFEC3, LFECP/EC10, LFECP/EC15 to Pin Information
			Added LFEC1, LFEC3, LFECP/EC10, LFECP/EC15 to Power Supply and NC Connections
			Added LFEC1 and LFEC3 100 TQFP Pinout
			Added LFEC1 and LFEC3 144 TQFP Pinout
			Added LFEC1, LFEC3 and LFECP/EC10 208 PQFP Pinout
			Added LFEC3, LFECP/EC10 and LFECP/EC15 256 fpBGA Pinout
			Added LFECP/EC10 and LFECP/EC15 484 fpBGA Pinout
		Ordering Information	Added Lead-Free Package Designators
			Added Lead-Free Ordering Part Numbers
		Supplemental Information	Updated list of technical notes.
April 2005	01.5	Architecture	EBR memory support section has been updated with clarification.
			Updated sysIO buffer pair section.
		DC & Switching Characteristics	Hot Socketing Specification has been updated.
			DC Electrical Characteristics table (I_{IL} , I_{IH}) has been updated.
			Supply Current (Standby) table has been updated.
			Initialization Supply Current table has been updated.
			External Switching Characteristics section has been updated.
			Removed t_{RSTW} spec. from PLL Parameter table.
			t_{RST} specifications have been updated.
			sysCONFIG Port Timing Specifications (t_{BSCL} , t_{ODISS} , t_{PRGMRJ}) have been updated.
		Pinout Information	Added LFECP/EC33 Pinout Information
			Pin Information Summary table has been updated.
			Power Supply and NC Connection table has been updated.
			484-fpBGA logic connection has been updated (Ball # J6, J17, P6 and P17 for ECP/EC33 are now called VCCPLL).
			672-fpBGA logic connection has been updated (Ball # K19, L8, U19, U8 for ECP/EC33 are now called VCCPLL).
May 2005	01.6	Introduction	ECP/EC33 EBR SRAM Bits and Blocks have been updated to 498K and 54 respectively.
		Architecture	Table 2-10 has been updated (ECP/EC33 EBR SRAM Bits and Blocks have been updated to 498K and 54 respectively.)
			Recommended Power Up Sequence section has been removed.
		DC & Switching Characteristics	Supply Current (Standby) table has been updated.
			Initialization Supply Current table has been updated.
			Vos test condition has been updated to $(VOP+VOM)/2$.
			Register-to-Register performance table has been updated (rev. G 0.27).
			External switching characteristics have been updated (rev. G 0.27).
			Internal timing parameters have been updated (rev. G 0.27).
			Timing adders have been updated (rev. G 0.27).
			sysCONFIG port timing specifications have been updated.
		Pinout Information	Pin Information Summary table has been updated.
			Power Supply and NC Connection table has been updated.
		Ordering Information	OPN list has been updated.

Date	Version	Section	Change Summary
September 2005	02.0	Architecture	sysIO section has been updated.
		DC & Switching Characteristics	Recommended Operating Conditions has been updated with V_{CCPLL} .
			DC Electrical Characteristics table has been updated
			Removed 5V Tolerant Input Buffer section.
			Register-to-Register performance table has been updated (rev. G 0.28).
			LatticeECP/EC External Switching Characteristics table has been updated (rev. G 0.28).
			LatticeECP/EC Internal Switching Characteristics table has been updated (rev. G 0.28).
			LatticeECP/EC Family Timing Adders have been updated (rev. G 0.28).
			sysCLOCK PLL timing table has been updated (rev. G 0.28)
			LatticeECP/EC sysCONFIG Port Timing specification table has been updated (rev. G 0.28).
			Master Clock table has been updated (rev. G 0.28).
			JTAG Port Timing specification table has been updated (rev. G 0.28).
		Pinout Information	Signal Description table has been updated with V_{CCPLL} .
November 2005	02.1	DC & Switching Characteristics	Pin-to-Pin Performance table has been updated (G 0.30) - 4:1MUX, 8:1MUX, 16:1MUX, 32:1MUX
			Register-to-Register Performance (G 0.30) - No timing number changes.
			External Switching Characteristics (G 0.30) - No timing number changes.
			Internal Switching Characteristics (G 0.30) t_{SUP_DSP} , t_{HP_DSP} , t_{SUO_DSP} , t_{HO_DSP} , t_{COI_DSP} , t_{COD_DSP} numbers have been updated.
			Family Timing Adders (G 0.30) - No timing number changes.
			sysCLOCK PLL Timing (G 0.30) - No timing number changes.
			sysCONFIG Port Timing Specifications (G 0.30) - No timing number changes.
			Master Clock (G 0.30) - No timing number changes.
			JTAG Port Timing Specification (G 0.30) - No timing number changes.
		Ordering Information	Added 208-PQFP lead-free part numbers.
March 2006	02.2	DC & Switching Characteristics	Added footnote 3. to V_{CCAUX} in the Recommended Operating Conditions table.
January 2007	02.3	Architecture	EBR Asynchronous Reset section added.
February 2007	02.4	Architecture	Updated EBR Asynchronous Reset section.
			Updated Maximum Number of Elements in a Block table - MAC value for x9 changed to 2.
May 2007	02.5	Architecture	Updated text in Ripple Mode section.
November 2007	02.6	DC & Switching Characteristics	Added JTAG Port Waveforms diagram.
			Updated t_{RST} timing information in the sysCLOCK PLL Timing table.
		Pinout Information	Added Thermal Management text section.
		Supplemental Information	Updated title list.
February 2008	02.7	DC & Switching Characteristics	Read/Write Mode (Normal) and Read/Write Mode with Input and Output Registers waveforms in the EBR Memory Timing Diagrams section have been updated.
September 2012	02.8	All	Updated document with new corporate logo.